

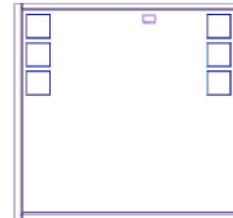
MMIC

# REFLECTIONLESS FILTER DICE

50Ω DC to 21 GHz

## The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD\* process
- Unpackaged Die Form



**X-Series**

Available in Low Pass, High Pass and Band Pass designs

## Product Overview

Mini-Circuits' X-Series reflectionless filters employ a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolators, isolation amplifiers or attenuators.

### Key Features

Easy integration with sensitive reflective components, e.g. mixers, multipliers

Enables stable integration of wideband amplifiers

Cascadable

Excellent power handling in a tiny surface mount device

Excellent repeatability of RF performance

Excellent stability over temperature

Operating Temperature up to 105°C

Unpackaged Die form

### Advantages

Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.

Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.

Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.

High power handling extends the usability of these filters to the transmit path for inter-stage filtering.

Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.

With  $\pm 0.3$  dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.

Suitable for operation close to high power components

Enables direct integration into customer hybrids

\*IPD – Integrated Passive Device, is a GaAs semiconductor process



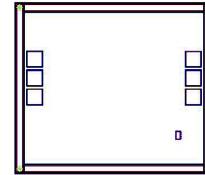
# Reflectionless High Pass Filter Die

## XHF-23-D+

50Ω      2010 to 10100 MHz

### Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Protected by US Patent No. 8,392,495



### Applications

- Wi-Fi
- WiMax
- Microwave Radio
- Military & Space

#### +RoHS Compliant

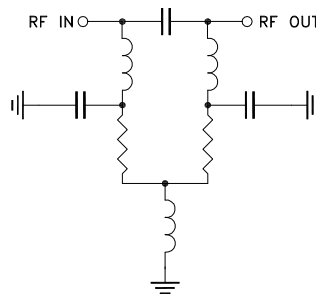
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

### General Description

Mini-Circuits' XHF-23-D+ reflectionless filter die employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

### Simplified Schematic



Pad	Description
RF-IN	RF Input Pad
RF-OUT	RF Output Pad
Ground	Ground Bonding Pad

**Electrical Specifications<sup>1</sup> at 25°C**

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
<b>Stop Band</b>	Rejection	DC-F1	DC-1210		14	dB
	Frequency Cut-off	F2	1650		3.0	dB
	VSWR	DC - F1	DC-1210		1.2	:1
<b>Pass Band</b>	Insertion Loss	F3-F5	2010 -10100		1.2	dB
	VSWR	F3-F4	2010 - 3200		1.6	:1
		F4-F5	3200 - 10100		2.0	:1

<sup>1</sup> Measured on Mini-Circuits Characterization test board. Die packaged in 3mm x 3mm, 12-lead MCLP package and soldered on TB-844-23H+

**Absolute Maximum Ratings<sup>1,4</sup>**

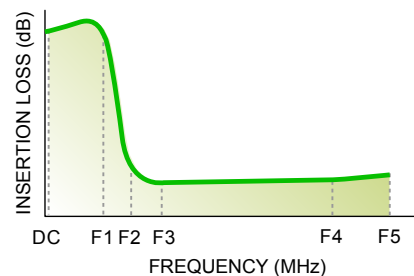
Parameter	Ratings
Operating Temperature	-55°C to +105°C
RF Power Input, Passband (F3-F5) <sup>2</sup>	2W at 25°C
RF Power Input, Stopband (DC-F3) <sup>3</sup>	0.5W at 25°C

<sup>2</sup> Passband rating derates linearly to 1W at 105°C ambient

<sup>3</sup> Stopband rating derates linearly to 0.25W at 105°C ambient

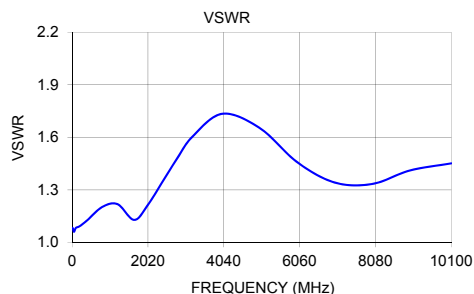
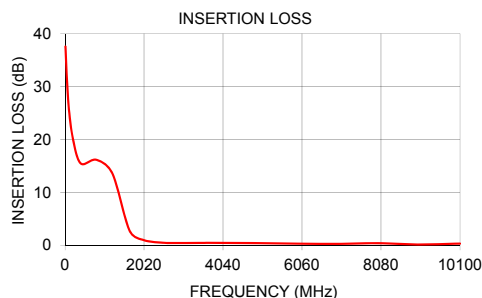
<sup>4</sup> Permanent damage may occur if any of these limits are exceeded.

**Specification Definition**



**Typical Performance Data at 25°C<sup>1</sup>**

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	37.56	1.08
20	35.92	1.08
50	31.08	1.06
100	25.62	1.08
200	20.18	1.09
400	15.49	1.13
800	16.17	1.20
1210	13.58	1.22
1650	2.78	1.13
2010	1.00	1.21
2500	0.51	1.38
2800	0.45	1.48
3200	0.46	1.60
4000	0.48	1.73
5000	0.41	1.65
6000	0.32	1.46
7000	0.28	1.34
8000	0.42	1.33
9000	0.17	1.41
10100	0.34	1.45



**Die Layout**

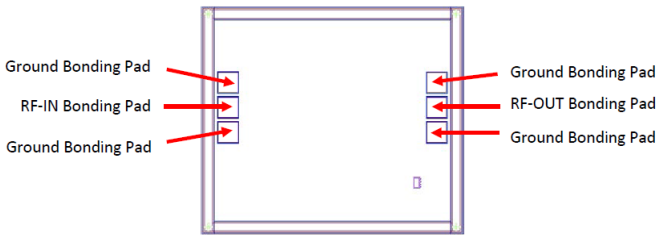


Fig 1. Die Layout

**Bonding Pad Position**  
(Dimensions in  $\mu\text{m}$ , Typical)

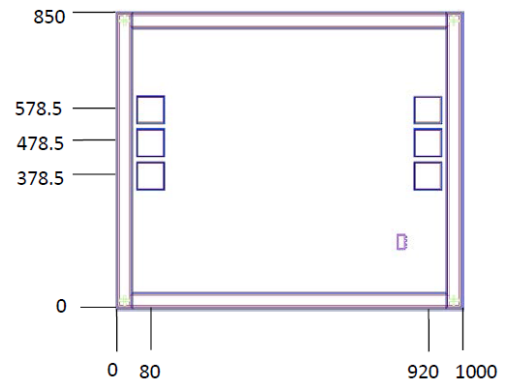


Fig 2. Bonding Pad Positions

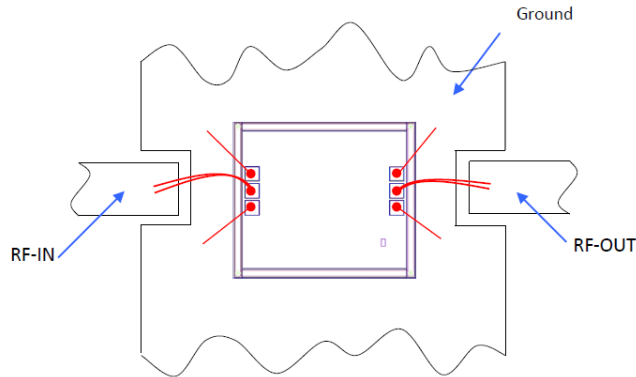
**Critical Dimensions**

Parameter	Values
Die Thickness, $\mu\text{m}$	100
Die Width, $\mu\text{m}$	1000
Die Length, $\mu\text{m}$	850
Bond Pad Size (Ground pad), $\mu\text{m}$	75 x 75

**Assembly and Handling Procedure**

1. Storage  
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD  
MMIC Gallium Arsenide (GaAs) filter dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. Die Attach  
The die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030Hk-PT/H579/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic die pick up tools only.
4. Wire Bonding  
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

**Assembly Diagram**



**Recommended Wire Length, Typical**

Wire	Wire Length (mm)	Wire Loop Height (mm)
All wires	1.0	0.15

Note: Use double bond wire at RF IN & RF OUT

<b>Additional Detailed Technical Information</b> <i>additional information is available on our dash board.</i>		
<b>Performance Data</b>	Data Table	
	Swept Graphs	
	S-Parameter (S2P Files) Data Set with and without port extension(.zip file)	
<b>Case Style</b>	Die	
<b>Die Ordering and packaging information</b>	Quantity, Package	Model No.
	Small, Gel - Pak: 10,50,100 KGD* Medium†, Partial wafer: KGD*<5K	XHF-23-DG+ XHF-23-DP+
	†Available upon request contact sales representative	
	Refer to <a href="#">AN-60-067</a>	
<b>Environmental Ratings</b>	ENV-80	

\*Known Good Dice ("KGD") means that the dice are taken from PCM good wafer and visually inspected according to Mini-Circuits inspection criteria. While this is not definitive, it does help to provide a higher degree of confidence that dice are capable of meeting typical RF electrical parameters specified by Mini-Circuits.

## ESD Rating\*\*

Human Body Model (HBM): Class 2 (2000 to <4000V) in accordance with ANSI/ESD STM 5.1 - 2001

\*\* Tested in industry standard MCLP 3x3mm 12 lead package.

## Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
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Typical Performance Data

FREQ.  (MHz)	INSERTION LOSS					GROUP DELAY				
	(dB)					(nsec)				
	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C
10	39.70	39.31	37.51	36.61	36.21	-3.16	-3.38	-3.22	-3.10	-2.96
50	31.25	31.18	30.94	30.68	30.57	-1.76	-1.88	-1.87	-1.85	-1.81
100	25.75	25.74	25.68	25.61	25.59	-0.23	-0.26	-0.34	-0.41	-0.43
200	20.20	20.20	20.21	20.21	20.21	0.16	0.15	0.13	0.12	0.11
400	15.47	15.48	15.52	15.54	15.56	0.21	0.21	0.20	0.20	0.20
600	14.22	14.23	14.29	14.34	14.36	0.20	0.20	0.20	0.19	0.19
800	15.94	15.97	16.08	16.17	16.20	0.14	0.13	0.12	0.10	0.10
1000	24.99	24.97	24.82	24.56	24.45	-1.54	-1.55	-1.56	-1.54	-1.53
1100	22.59	22.37	21.54	20.90	20.70	-1.42	-1.38	-1.20	-1.08	-1.04
1200	14.78	14.70	14.38	14.12	14.04	0.01	0.00	0.00	0.00	0.00
1210	14.21	14.13	13.84	13.60	13.52	0.05	0.05	0.04	0.04	0.04
1300	10.10	10.05	9.90	9.78	9.74	0.24	0.24	0.23	0.22	0.22
1400	6.97	6.95	6.88	6.83	6.82	0.30	0.30	0.29	0.28	0.28
1500	4.81	4.81	4.80	4.79	4.80	0.31	0.30	0.30	0.29	0.29
1600	3.35	3.35	3.37	3.40	3.41	0.29	0.29	0.28	0.28	0.28
1650	2.80	2.81	2.84	2.88	2.89	0.28	0.27	0.27	0.26	0.26
1700	2.36	2.37	2.41	2.45	2.47	0.26	0.26	0.25	0.25	0.25
1800	1.70	1.71	1.76	1.81	1.83	0.23	0.23	0.22	0.22	0.22
1900	1.26	1.28	1.33	1.38	1.40	0.20	0.20	0.19	0.19	0.19
2000	0.97	0.98	1.04	1.09	1.11	0.17	0.17	0.17	0.17	0.17
2010	0.95	0.96	1.02	1.07	1.09	0.17	0.17	0.17	0.17	0.16
2100	0.77	0.79	0.84	0.89	0.91	0.15	0.15	0.15	0.15	0.15
2200	0.64	0.65	0.71	0.75	0.77	0.12	0.12	0.12	0.12	0.12
2300	0.54	0.55	0.61	0.65	0.67	0.11	0.11	0.11	0.11	0.11
2400	0.48	0.49	0.54	0.59	0.60	0.11	0.11	0.11	0.11	0.11
2500	0.43	0.44	0.50	0.54	0.55	0.10	0.10	0.10	0.10	0.10
2600	0.41	0.42	0.47	0.50	0.52	0.09	0.09	0.09	0.09	0.09
2700	0.39	0.40	0.45	0.49	0.50	0.09	0.09	0.09	0.09	0.09
2800	0.38	0.39	0.43	0.48	0.49	0.08	0.08	0.08	0.08	0.08
2900	0.37	0.38	0.42	0.47	0.48	0.07	0.07	0.07	0.07	0.07
3000	0.37	0.37	0.42	0.47	0.48	0.07	0.07	0.07	0.07	0.07
3100	0.36	0.37	0.42	0.46	0.48	0.06	0.06	0.06	0.06	0.06
3200	0.37	0.38	0.42	0.46	0.48	0.06	0.06	0.06	0.06	0.06
3300	0.37	0.38	0.42	0.46	0.48	0.05	0.05	0.05	0.05	0.05
3400	0.37	0.38	0.42	0.47	0.48	0.05	0.05	0.05	0.05	0.05
3500	0.38	0.39	0.42	0.47	0.49	0.05	0.05	0.05	0.05	0.05
3600	0.39	0.39	0.42	0.47	0.49	0.04	0.04	0.05	0.05	0.05
3700	0.39	0.39	0.43	0.47	0.49	0.04	0.04	0.04	0.04	0.04
3800	0.38	0.39	0.42	0.46	0.48	0.04	0.04	0.04	0.04	0.04
3900	0.38	0.39	0.42	0.46	0.48	0.04	0.04	0.04	0.04	0.04
4000	0.38	0.39	0.42	0.46	0.48	0.04	0.04	0.04	0.04	0.04
4200	0.39	0.39	0.42	0.46	0.48	0.03	0.03	0.04	0.04	0.04
4400	0.39	0.39	0.42	0.45	0.47	0.03	0.03	0.03	0.03	0.03
4600	0.38	0.38	0.41	0.44	0.46	0.03	0.03	0.03	0.03	0.03
4800	0.36	0.37	0.40	0.44	0.45	0.03	0.03	0.03	0.03	0.03
5000	0.37	0.37	0.39	0.42	0.43	0.03	0.03	0.03	0.03	0.03
5200	0.36	0.36	0.38	0.41	0.42	0.03	0.03	0.03	0.03	0.03
5400	0.36	0.36	0.37	0.40	0.42	0.03	0.03	0.03	0.03	0.03
5600	0.35	0.34	0.36	0.38	0.39	0.02	0.02	0.03	0.03	0.03
5800	0.33	0.33	0.35	0.37	0.38	0.02	0.02	0.03	0.03	0.03
6000	0.32	0.32	0.33	0.37	0.38	0.02	0.02	0.03	0.03	0.03
6200	0.30	0.30	0.31	0.35	0.36	0.02	0.02	0.02	0.03	0.03
6400	0.27	0.27	0.30	0.34	0.36	0.02	0.02	0.02	0.03	0.03
6600	0.25	0.25	0.29	0.35	0.37	0.02	0.02	0.02	0.03	0.03
6800	0.21	0.22	0.27	0.34	0.37	0.02	0.02	0.02	0.03	0.02
7000	0.18	0.19	0.26	0.34	0.37	0.02	0.02	0.02	0.02	0.02
7200	0.14	0.15	0.24	0.34	0.38	0.02	0.02	0.02	0.02	0.02
7400	0.12	0.13	0.21	0.33	0.38	0.02	0.02	0.02	0.02	0.02
7600	0.10	0.11	0.20	0.32	0.36	0.02	0.02	0.02	0.02	0.02
7800	0.09	0.10	0.17	0.29	0.34	0.02	0.02	0.02	0.02	0.02
8000	0.10	0.10	0.16	0.26	0.31	0.02	0.02	0.02	0.02	0.02
8200	0.12	0.12	0.14	0.21	0.25	0.02	0.02	0.02	0.02	0.02
8400	0.14	0.13	0.12	0.16	0.19	0.02	0.02	0.02	0.03	0.02
8600	0.18	0.16	0.11	0.13	0.15	0.02	0.02	0.03	0.03	0.03
8800	0.21	0.19	0.11	0.06	0.07	0.02	0.02	0.03	0.03	0.03
9000	0.23	0.21	0.09	0.00	0.01	0.02	0.02	0.03	0.03	0.03
9200	0.23	0.21	0.07	0.05	0.07	0.02	0.02	0.03	0.03	0.03
9400	0.22	0.20	0.06	0.09	0.13	0.02	0.02	0.03	0.03	0.04
9600	0.24	0.22	0.10	0.04	0.10	0.02	0.02	0.03	0.04	0.04
9800	0.28	0.27	0.18	0.06	0.00	0.02	0.02	0.03	0.03	0.04
10000	0.29	0.28	0.24	0.16	0.10	0.02	0.02	0.03	0.03	0.04
10100	0.30	0.30	0.26	0.23	0.17	0.03	0.03	0.03	0.03	0.03
10500	0.36	0.36	0.41	0.53	0.55	0.03	0.03	0.03	0.03	0.03
11000	0.53	0.54	0.69	0.98	1.07	0.03	0.03	0.03	0.02	0.02
11500	1.01	1.01	1.19	1.48	1.61	0.02	0.02	0.02	0.01	0.01
12000	1.73	1.72	1.79	1.97	2.06	0.01	0.01	0.01	0.01	0.01



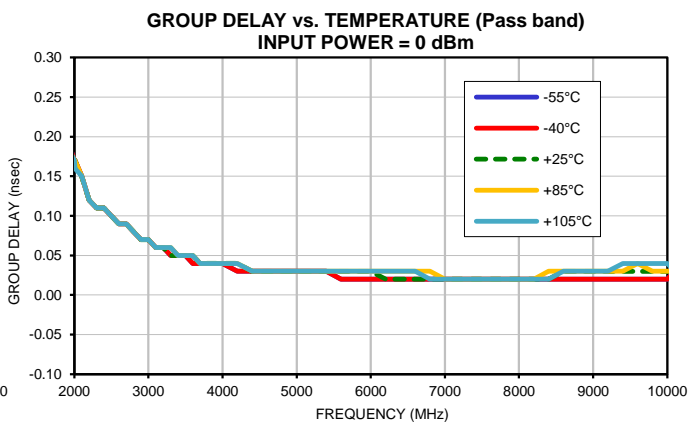
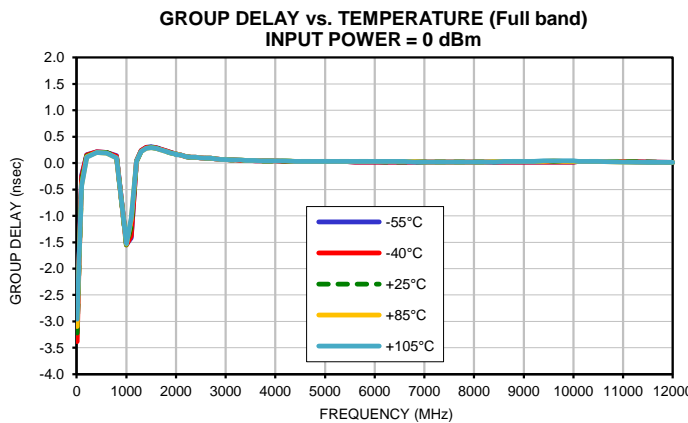
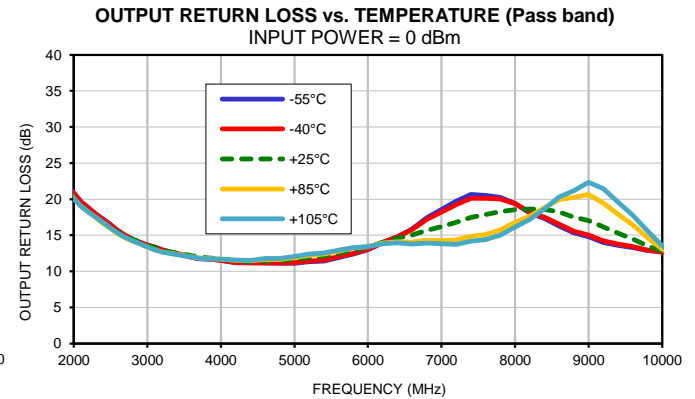
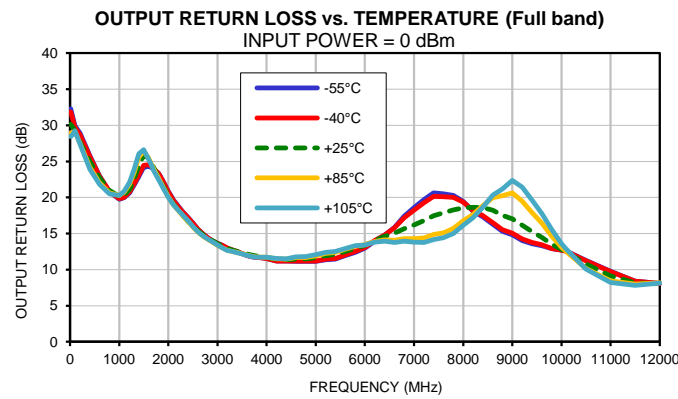
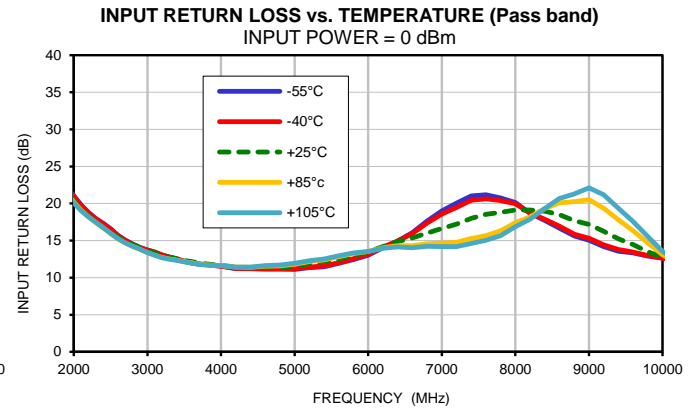
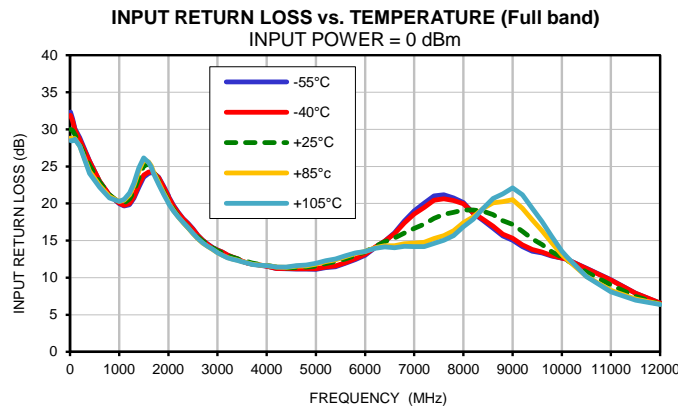
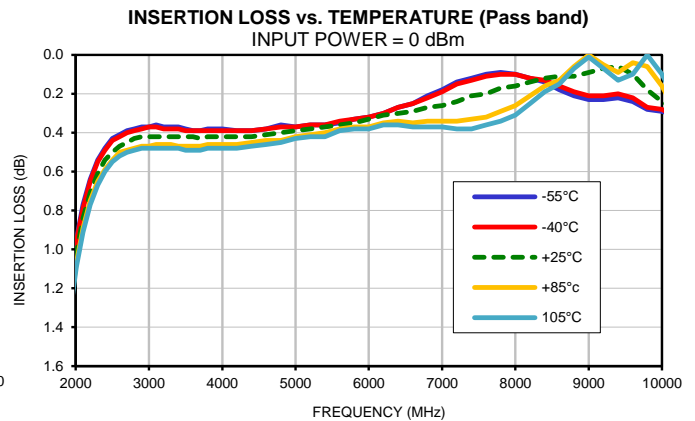
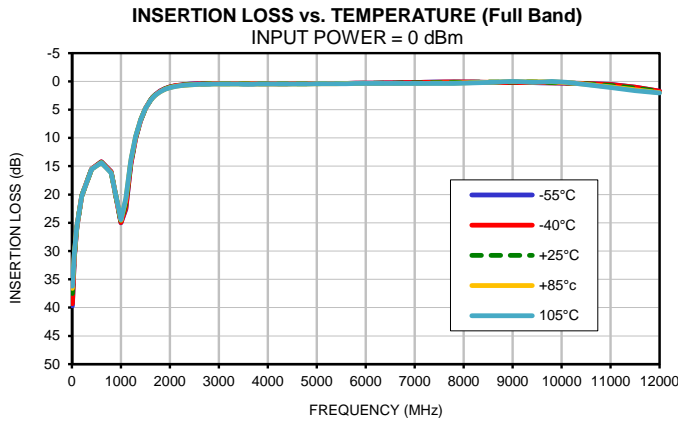
Typical Performance Data

FREQ.  (MHz)	INPUT RETURN LOSS					OUTPUT RETURN LOSS				
	(dB)					(dB)				
	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C
10	32.33	31.89	30.00	28.83	28.47	32.30	31.86	30.14	28.97	28.44
50	31.42	31.16	29.84	28.76	28.46	31.22	30.92	29.76	28.94	28.69
100	30.11	29.94	29.29	28.75	28.66	29.94	29.71	29.25	29.2	29.23
200	28.86	28.58	27.95	27.73	27.74	28.92	28.69	27.79	27.53	27.44
400	25.72	25.67	25.13	24.37	24.06	25.77	25.65	24.96	24.2	23.9
600	22.96	22.99	22.90	22.41	22.17	22.99	22.96	22.69	22.07	21.82
800	21.14	21.14	21.18	20.93	20.77	20.82	20.86	20.99	20.65	20.51
1000	19.97	20.04	20.14	20.29	20.27	19.77	19.85	20.16	20.27	20.3
1100	19.66	19.75	20.07	20.44	20.55	19.95	20.02	20.31	20.74	20.87
1200	19.83	19.96	20.54	21.10	21.32	20.56	20.67	21.01	21.72	21.98
1210	19.87	20.02	20.61	21.18	21.41	20.64	20.75	21.11	21.83	22.1
1300	20.72	20.92	21.68	22.41	22.75	21.69	21.87	22.43	23.45	23.87
1400	22.20	22.48	23.45	24.35	24.80	22.90	23.13	24.41	25.57	26.06
1500	23.56	23.83	25.08	25.88	26.14	24.20	24.45	25.85	26.45	26.61
1600	24.06	24.24	25.32	25.61	25.54	24.30	24.54	25.45	25.38	25.24
1650	24.15	24.27	24.97	25.12	24.96	24.17	24.33	24.94	24.78	24.61
1700	24.08	24.16	24.31	24.28	24.06	23.90	24.01	24.17	23.97	23.76
1800	23.53	23.47	22.98	22.81	22.57	23.32	23.31	22.86	22.66	22.46
1900	22.36	22.24	21.64	21.44	21.26	22.15	22.08	21.50	21.34	21.2
2000	21.07	20.95	20.38	20.19	20.07	20.86	20.79	20.23	20.09	20.03
2010	20.91	20.80	20.22	20.04	19.92	20.72	20.65	20.08	19.96	19.89
2100	19.78	19.67	19.23	19.08	19.02	19.65	19.58	19.11	19.01	18.99
2200	18.81	18.72	18.30	18.19	18.18	18.82	18.75	18.23	18.2	18.22
2300	17.97	17.90	17.47	17.42	17.45	17.96	17.91	17.43	17.45	17.51
2400	17.35	17.26	16.75	16.70	16.75	17.23	17.17	16.68	16.69	16.78
2500	16.58	16.52	16.07	15.93	15.98	16.47	16.44	15.99	15.9	15.99
2600	15.72	15.69	15.46	15.23	15.28	15.64	15.63	15.39	15.21	15.27
2700	15.06	15.03	14.94	14.65	14.69	14.98	14.97	14.88	14.64	14.69
2800	14.52	14.50	14.48	14.21	14.24	14.44	14.44	14.43	14.2	14.24
2900	14.07	14.05	14.05	13.80	13.82	14.00	13.99	14.02	13.79	13.83
3000	13.72	13.71	13.66	13.39	13.39	13.63	13.64	13.62	13.38	13.4
3100	13.44	13.43	13.32	13.03	13.01	13.35	13.36	13.28	13	12.99
3200	13.04	13.07	12.98	12.71	12.69	12.96	12.99	12.95	12.69	12.67
3300	12.75	12.79	12.74	12.52	12.49	12.67	12.72	12.71	12.52	12.5
3400	12.52	12.55	12.55	12.37	12.33	12.46	12.50	12.53	12.37	12.33
3500	12.19	12.22	12.34	12.17	12.13	12.19	12.22	12.35	12.2	12.16
3600	11.96	11.99	12.17	12.00	11.96	11.94	11.97	12.17	12.02	11.99
3700	11.80	11.84	11.99	11.82	11.77	11.75	11.79	11.99	11.85	11.81
3800	11.74	11.77	11.87	11.74	11.69	11.69	11.72	11.87	11.76	11.72
3900	11.64	11.67	11.75	11.68	11.65	11.64	11.65	11.79	11.74	11.72
4000	11.54	11.56	11.65	11.63	11.61	11.53	11.53	11.69	11.71	11.7
4200	11.22	11.24	11.43	11.43	11.44	11.20	11.21	11.46	11.51	11.54
4400	11.19	11.23	11.31	11.39	11.42	11.17	11.19	11.36	11.47	11.52
4600	11.14	11.18	11.37	11.55	11.63	11.15	11.17	11.44	11.66	11.77
4800	11.16	11.21	11.43	11.59	11.69	11.14	11.18	11.47	11.67	11.8
5000	11.13	11.20	11.56	11.81	11.95	11.14	11.20	11.64	11.91	12.06
5200	11.36	11.44	11.89	12.16	12.30	11.36	11.44	11.92	12.24	12.4
5400	11.48	11.59	12.16	12.40	12.52	11.44	11.55	12.13	12.4	12.54
5600	11.93	12.03	12.50	12.83	12.93	11.93	12.03	12.51	12.82	12.93
5800	12.45	12.55	12.99	13.26	13.32	12.40	12.51	12.94	13.23	13.31
6000	13.04	13.12	13.48	13.54	13.53	12.96	13.06	13.37	13.43	13.42
6200	14.04	14.10	14.17	14.03	13.94	13.94	14.01	14.04	13.91	13.82
6400	14.92	14.92	14.83	14.30	14.14	14.76	14.78	14.59	14.11	13.96
6600	16.05	15.93	15.36	14.32	14.04	15.86	15.78	15.04	14.06	13.77
6800	17.64	17.38	16.02	14.59	14.22	17.40	17.18	15.69	14.31	13.93
7000	19.02	18.57	16.65	14.64	14.19	18.58	18.22	16.19	14.28	13.82
7200	20.04	19.46	17.23	14.77	14.18	19.72	19.24	16.78	14.36	13.75
7400	21.02	20.43	18.00	15.28	14.62	20.65	20.14	17.49	14.85	14.17
7600	21.17	20.64	18.54	15.68	15.03	20.52	20.12	17.89	15.1	14.42
7800	20.77	20.40	18.81	16.32	15.65	20.27	20.01	18.27	15.73	15.01
8000	20.12	19.96	19.12	17.40	16.86	19.42	19.35	18.56	16.79	16.15
8200	18.71	18.74	19.12	18.19	17.87	18.10	18.20	18.62	17.63	17.18
8400	17.72	17.87	18.95	19.31	19.31	17.31	17.50	18.59	18.84	18.64
8600	16.69	16.94	18.51	20.11	20.67	16.28	16.53	18.25	19.95	20.31
8800	15.64	15.87	17.69	20.23	21.28	15.33	15.55	17.51	20.24	21.18
9000	15.06	15.30	17.19	20.51	22.11	14.81	15.03	17.03	20.64	22.36
9200	14.18	14.43	16.24	19.35	21.17	14.02	14.23	16.15	19.47	21.45
9400	13.58	13.78	15.25	17.78	19.36	13.59	13.76	15.28	17.9	19.6
9600	13.32	13.46	14.44	16.32	17.55	13.31	13.43	14.49	16.45	17.78
9800	12.90	12.98	13.48	14.68	15.56	12.90	12.94	13.54	14.66	15.58
10000	12.62	12.63	12.75	13.09	13.58	12.70	12.69	12.80	13.08	13.57
10100	12.48	12.46	12.35	12.49	12.84	12.55	12.52	12.42	12.48	12.83
10500	11.28	11.23	10.77	10.19	10.13	11.28	11.22	10.77	10.16	10.09
11000	9.73	9.67	9.03	8.30	8.09	9.78	9.71	9.14	8.44	8.21
11500	7.89	7.88	7.46	7.11	6.95	8.40	8.39	8.16	8.01	7.83
12000	6.55	6.58	6.43	6.43	6.38	8.10	8.08	8.03	8.18	8.12





## Typical Performance Curves



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment	Refer to Individual Model Data Sheet
Storage Environment (Die)	-65° to 150°C	Individual Model Data Sheet
Storage Environment(Packaging)	-40° to 70°C and 40 to 60% humidity (In Factory Shipped Package)	